



#### Technical challenges for the new T2K High Angle TPCs

19 July 2024

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on behalf of the T2K ND280 upgrade group



#### **Outlook**

- The T2K ND280 experiment
- The ND280 upgrade project
  - The motivations
  - The upgrade
- The High Angle Time Projection Chambers (HATPC)
  - Mechanical constrains
  - Electrical constrain and performance
- The Encapsulated Resistive Anode Micromegas (ERAM)
  - Construction
  - Quality assessment
- Conclusions





# The T2K experiment and the role of ND280



•  $v_e$  and  $\bar{v}_e$  appearance  $\rightarrow$  determine  $\theta_{13}$  and  $\delta_{CP}$ 

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• Precise measurement of  $\nu_{\mu}\,disappearance \rightarrow \theta_{23}$  and  $|\Delta m^2{}_{32}|$ 

Several detectors installed to monitor the beams reduce systematic uncertainties in oscillation analyses, and measure  $\nu$  and  $\bar{\nu}$  cross-sections

ND to measure un-oscillated beam flux and v cross sections



## The ND280 experiment: the upgrade

momentum (MeV)

Muons in TPC or

stopping in SuperFGD

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#### ND280: the upgrade detectors



#### **ND280: installations at J-PARC**

TOF installation (July 2023)





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Bottom TPC installation (September 2023)



Super-FGD installation (October 2023)



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#### N280: commissioning at JPARC with cosmics



- Detector commissioning with and without magnetic field
- Alignment runs
- New software deployment
- New T2K gas system commissioning for both vertical and horizontal TPCs



#### N280: v technical runs in December 2023 and February 2024 physics run



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#### ND280: upgrade completed! Top-HATPC installed in the end of April 2024





#### ND280: upgrade completed! Top-HATPC installed in the end of April 2024





## The T2K run schedule: beam upgrade

#### v beam @ J-PARC: dedicated upgrade of the MR facility to reach the 1.3 MW beam power



Protons per spill	[-]	3.30E+14	3.20E+14
Energy deposited per kg per proton	[J/kg/proto n]	2.52E-10	2.52E-10
Energy deposited per kg per pulse	[J/kg/pulse]	83300	80640
Cycle time	[5]	2.1	1.16
Spill length	[5]	4.13E-06	4.11E-06
Number of bunches	[-]	8	8
Bunch length	[ns]	58	40
Gap length	[ns]	523	541
Peak Heat Generation	[J/m^3/s]	8.15E+14	1.14E+15
Beam sigma	[mm]	4.24	4.24
Heat load per spill	[J/cc/pulse]	378,18	366.11
Heat load per sec	[W/cc]	180.09	315.61
Peak Temp per bunch	[C]	19.78	19.15
Thermal stress per bunch	[MPa]	61,27	59.32
Peak Temp per pulse	[C]	158.27	153.22
VK(	3	2	Science & Technology Facilities Coun Rutherford Appleton

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MR Run#	91	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		and the second se	• • ×
MR Shot#	1164758 2023/12/25 12:00:27)	MR Pov	ver:	764.0	[kW]
NU Run#	910328	Expected PPP :	2.0040	e+14 (protons p	er spillj
Event#	1683	Parameter values	2.3011	Last shot :	
Spill#	2611625	LI current: MR micro pulse:	62.20 [mA] 400 [usec]	MR shot#: NU spill#:	1164758 2611625
Deliv. p#	2.05456e+20	MR chop width:	455 [nsec]	NU event#:	1683
(this J-PARC run)	2.001000120	MR # of bunch:	104/128	MR Power:	764.0 (DCCT1)
Deliv. p# (2010/Jan/1~)	4.02699e+21	Last shot NU	Power is	776.9	[ <b>kW</b> ] (CT1)



Expect to select 20k  $\nu_{\mu}$  CC0pi interactions in the super-FGD for 0.2e21 POT (1 month)

December 2023 → Beam power increased from 500 to 760 kW stable mode 800 kW reached in 2024 for the first run with the fully upgraded ND280



Steady improvements to reach 1.3 MW by 2027 with an increase T2K statistics ~ a factor of 3 by 2027

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# The ND280 experiment: High Angle TPC highlights

- Field Cage (FC)
  - Assembly
  - Production
  - Characterization and Quality Assessment
    - Mechanical
    - Electrical
- Encapsulated Resistive Anode Micromegas (ERAMS)
  - Production of 50 sensors
  - Characterization
  - Detector response, signal and impact on reconstruction
- Impact on HATPC performance



# The ND280 experiment: physics requirements

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Momentum resolution  $\sigma_p/p < 9\%$  at 1GeV/c (neutrino energy)

Energy resolution  $\sigma_{dE/dx} < 10\%$ (PID muons and electrons)

Space resolution O(500 μm) (3D tracking & pattern recognition)

Low material budget walls ~  $3\% X_0$ (matching tracks from neutrino active target)

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Resistive MicroMegas sensors (ERAMs)

- Overall anode active surface ~ O(3m<sup>2</sup>)
- Sampling length ~ 80-160 cm
- pads ~ 1x1cm<sup>2</sup>
- 10k+10k channels / TPC @ End Plates (Anodes)

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## HATPC: features, challenges, constrains and solutions

#### **Mechanics and Electric Field uniformity**

• Min dead space & max active volume in the dipole magnet

→Rectangular shape & thinnest walls & field shaping electrodes incorporated into the walls

- Electric field uniformity better than 10<sup>-3</sup> @1cm from walls
  - $\rightarrow$  Mechanical accuracy: inner surfaces planarity & parallelism ~ O(0.2mm/m)
  - → Shaping Electrode design: Field and Mirror copper strip layers on two sides
- of a Kapton foil
- Low material budget walls
  - → lightweight & lowest Z & robust (self supporting)

#### **Electrical insulation Constrains**

• HV insulation mantle R > 1TOhm and volume resistivity, HV

→geometry: several cm paths for charge from -HV strips to GND shielding (cathode flanges)

→insulating materials: very high resistivity & dielectric strength





## HATPC: features, challenges, constrains and solutions

**Building process:** hand lay-up of composite materials on a Mould & polymerization in autoclave at high Pressure

Autoclave dimensions

→ Field Cage comprising two halves (symmetrical flanges at central cathode position)

• Hand layup & large dimensions

 $\rightarrow$  several hours per process step  $\rightarrow$  very long pot life for epoxy resin

• Mechanical accuracy of geometry  $\rightarrow$  resin curing at low T < O(40°C)

#### **Materials of choice**

- lamination materials: Aramid polymers for peels (Twaron) and for honeycomb (Nomex paper)
- epoxy resin limited choice: Resoltech 1054 combined with quality control against contaminants (moisture, ...)
- high insulation layers: Kapton
- box skeleton material: high quality laminated G10





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#### **Mechanical HATPC Field Cage assembly**





#### Field Cage: walls stack up layout



#### Electric field shaping by two Cu strips layers ('Field' and 'Mirror' strips)





# Field cage mechanical details: charge path to gnd

Flange thickness (5cm) too small for degrading -30kV to GND over a flat surface

Three deep grooves for extending the path from HV to GND for charge moving on surface and with gas flanges

- ~ 7cm thick labirinth
- ~14 cm path lenght

 $\rightarrow$  voltage drop / path length < 3kV/cm

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#### Field Cage building, assembling and characterization

Production at NEXUS company (Barcelona) ~ 10 weeks Validation, QC, electrical and mechanical assembly at CERN ~ 4 weeks

#### Mold features

- 1cm thick Alu walls
- Anodyzd. Surfaces
- Waviness compl. iso1302 N8
- Surfaces ⊥ and ∥ better than 80µm/m
- Mount / unmount geom. reproducibility with high precision



Mould building

# Field Cage building, assembling & characterization at NEXUS Kapton Layer Production at NEXUS company (Barcelona) ~ 10 weeks

Validation, QC, electrical and mechanical assembly at CERN ~ 4 weeks



#### 5 m perimeter x 1m height (drift length)

- Mold preparation
- Inner Vacuum bag
- Strip Foil positioning

Strip foil (by CERN) alignment and

lamination of 3 Kapton layers



- Kapton lamination
- Curing at 40C (fast)
- Electrical tests on surfaces and resin samples after curing
- ATC
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Thick corners w/ Kapton tape

**Resin samples electrical Tests** 

Electrical tests on surfaces

#### Field Cage building, assembling & characterization at NEXUS Kapton Layer and inner Twaron

# Inner Twaron peel lamination

- First Twaron layer lamination
- Curing at 40C (fast) in autoclave

#### **Electrical tests**

Resin sampleInner Twaron layer





#### Quality controls - Resistivity of early Layers

1) Resistance between mold and 40x45cm2 electrode -> volume resistivity of layers



3) Resistance between two 6x80cm2 electrodes-> mix of surface and volume resistivity





(Resoltech Epoxy)

2) Surface resistivity of last layer Twaron





- various methods and electrode types (optimizing contact)
  → consistent measurements
- 2) Resin sample ρ<sub>S</sub> ~ 10 TΩ/□ → very good

#### Field Cage building, assembling & characterization at NEXUS Kapton Laver + inner Twaron + G10 Skeleton

Callan

- G10 skeleton gluing
- Curing 40C in clean room

Gluing G10 "skeleton"

Gluing G10 structural skeleton and casting resin on flanges for ensuring gas tightness





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Flanges & Bars by **ORVIM** company (TV, Italy)





- Casting low viscosity resin on top flange  $\rightarrow$  sealing flange to laminated layers
- Autoclave curing at 40C

#### Field Cage building, assembling & characterization at NEXUS Kapton Layer + inner Twaron + G10 Skeleton + HC + Ext Twaron

- Gluing Nomex Honeycomb
- Curing at 40C in oven





- Flipping the box top-bottom
- Resin casting on second flange
- Curing at 40C in autoclave
- Second Twaron peel lamination
- Curing at 40C in autoclave



#### Outer Twaron peel lamination



Post-curing at 40C in oven (lasting as long as possible)

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## Field Cage machining and final QC at Nexus



- Back to NEXUS company for
- Mould removal
- Very fine polishing of flanges
- Correction of defects (eg bubbles)









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#### Inner cage surfaces polishing





Checking grooves for o-ring and for charge labyrinth on cathode flanges Looking for defects on strips and strip-strip short-circuits and repairing them



Soldering voltage divider resistors



Two voltage dividers In parallel ~400 5.1MΩ resistors each: Overall R ~ 1GΩ





Measuring strip-strip and strip-shield insulation at high voltage



selection. resistance values show better than

Measuring single resistors



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Mantle Resistance >  $2T\Omega$  ~ 2000 x voltage divider R

# Vertical assembly of two Field Cages into HATPC



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Cathode assembly





Cathode assembly



Connection of last strips to cathode and to high voltage feedtrough







High Voltage feedtrough external connection

#### High voltage tests after assembly





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- 1) He leak tested sniffer (air + 30mbar of He)
- 2) Tested against gas density changes
- He Over-pressure (+20mbar)
- Air Under-pressure (-20mbar)



#### Gas leakages qualification

[mbar]



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Mechanical qualification

Comparison with FEM models in fair agreement with

- load tests
- deformation vs pressure





## Field Cage assembling, metrology at Nexus

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# Field Cage assembling, metrology at CERN



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CERN EP Detector Semi 300 $\mu m$  with few localized, acceptable exceptions
## Field Cage assembling, ERAM installation

#### Assembly the 16 ERAMs in Clean room for each TPC

Grey tent area in front of Clean Room large entrance for enhanced clean conditions



ERAMs: avoid dust



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### Field Cage assembling, commissioning with cosmics









Projection on Anode End Plate 1



Cosmic tracks interaction evwnt



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### Field Cage assembling, commissioning: gas contamination at CERN



### Field Cage assembling, commissioning: gas contamination at J-PARC



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### Field Cage assembling, commissioning: drift velocity measurement



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# An outsider: Field Cage 0 ? Electrical Issues, what we understood... and learnt



### Insulation issue in full scale FC0 prototype



Current drawn by voltage divider starting in large excess wrt nominal at power on and slowly decreasing to lower value but still in excess Current drawn by voltage divider starting in large excess wrt nominal at power on and slowly decreasing to lower value but still in excess



Observed extra-currents in excess w. r. t. expected from voltage divider



### Insulation issue in full scale FC0 prototype

#### Innermost layers stack (first full-scale FC prototype)

Material	Thickness	
Cu Strips on Kapton foil (electrodes)	Cu 17µm / Kapton 50µm / Cu 17µm	-
"Coverlay" (strip insulation / protection)	Glue 20µm / Kapton 25µm	
Aramid Fiber Fabric (Twaron™)	2mm	

#### Strip-Strip Potential difference of the strips @ 5kV

Voltage difference between Field strips (every 5 strips) ie  $V_1$ - $V_2$ ,  $V_5$ - $V_6$ ,  $V_{10}$ - $V_{11}$ , ...  $V_1$  = anode,  $V_{196}$  = cathode



#### Measurement of Surface resistance of strip foil

(resistors removed)



Resistance between single strips is very high  $O(T\Omega)$  ...but when joining some tens of strips to form a single large electrode then finite resistances are measured

"field strips"

"mirror strips"

Example: measured R ~15 G $\Omega$  @ 1kV between two electrodes formed by 20Field+20Mirror strips each (surface of single electrode is huge ~ 0.5m<sup>2</sup>) ! No voltage divider there, ie all strips disconnected

Resistance is

- Independent of the distance between electrodes
- Linearly dependent of the number of the strips
   → not a surface resistance !

Measured R is rising with time (slow) up to saturation - when repeating measurement, go faster to saturation - when inverting polarity of electrodes, slow again → looks like due to dielectric polarization / relaxation → or capacitor charging trough high resistance

Find similar value of Resistance for same dimension \_\_\_\_\_\_ electrodes formed in the Field Cage and on a strips foil when aluminum foil is placed underneath the foil  $\rightarrow$  next \_\_\_44

### **Buried resistive layer: a possible explanation**

All observed features could be explained by the combination of two factors:

- 1) Presence of a resistive layer buried underneath the Kapton coverlay layer protecting the mirror Mirror strip
- 2) Low resistivity of the coverlay Kapton layer



### **Buried resistive layer: phenomenology**



After applying HV after applying HV (eg -10kV) to the cathode, two phases:

Transient state: in time scale depending on the contaminated layers resistivity (in our case very short O(10s) time scale) the buried resistive layer become ~ equipotential (setting at intermediate potential -5kV) by drawing charge from the strips

2) Steady state: Mirror strips on the Anode, first half convey current to the buried layer, while mirror strips on the Cathode side draw currents from the buried layer



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### **Buried resistive layer: verification**

#### In fact we verified the following

- 1) Coverlay Kapton volume resistivity ~  $1G\Omega cm$  much lower than datasheet)
- 2) Twaron layer facing the coverlay featured surface resistivity  $\sim 1G/\Box$



Both features could on turn be explained by the **accidental use of antistatic spray (resistive)** on the back of the strip foil (ie on the coverlay) after the strip foil was fixed on the Mould, in order to keep the huge foil surface (5m<sup>2</sup>) clean from dust and other possible contaminants. The spray contaminated both the Kapton coverlay (being very easily adsorbed) and the innermost layer of the Twaron (being mixed with the resin which impregnates the fiber fabric, during the Twaron lamination phase)

We could not exclude alternative sources of contamination affecting the resin and making it resistive (eg presence of water if epoxy not treated in vacuum after mixing)

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### **Buried resistive layer: electrical model**

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### **Buried resistive layer: electrical model results**



### **Buried resistive layer: electrical model results**



### **Buried resistive layer: fit to the data**





### **Buried resistive layer: electrical model results**



### Final layout, materials and procedures fixed for the series production



#### Production procedure and enhanced countermeasures and QC

- Minimize moisture trapped in wall layers: drying in oven Kapton & Twaron just before use
- QC epoxy contamination -> proper control of mixing and de-gassing process (new mixing / degassing tools and QC) and ... avoid antistatic spray...
- QC electrical resistivity measurements after each early step in the production

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### **ERAM: MicroMegas with DLC resistive foil**

## **Resistive layer** enables Charge spreading $\rightarrow$ space resolution below 500µm with larger pads

- $\rightarrow$  less FEE channels (lower cost)
- → improved resolution at small drift distance (where transverse diffusion cannot help)

#### **Resistive layer** prevents charge build-up and hides sparks

- $\rightarrow$  enables operation at higher gain
- $\rightarrow$  no need for spark protection circuits for ASICs
  - $\rightarrow$  compact FEE  $\rightarrow$  max active volume

#### Resistive layer encapsulated and properly insulated from GND

 $\rightarrow$  Mesh at ground and Resistive layer at +HV

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- $\rightarrow$  improved field homogeneity  $\rightarrow$  reduced track distortions
- $\rightarrow$  better shielding from mesh and DLC  $\rightarrow$  potentially better S/N





### **ERAM Module breakout**



36x32=1152 pads : 2 x 576 ch. FEC + 1 FEM2 + 1 PDC

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### Charge spread on *low* resistivity foil

#### Charge Spreading 2D telegraph eqn. solution time scale is driven by RC

R- surface resistivity

an

C- capacitance/unit area

 $\Gamma a^2 a$ 

#### Gaussian spread

$$\frac{\partial \rho}{\partial t} = h \left[ \frac{\partial^2 \rho}{\partial r^2} + \frac{1}{r} \frac{\partial \rho}{\partial r} \right] \implies \rho(r, t) = \frac{RC}{2t} e^{-r^2 RC/(4t)}$$
Find
$$\sigma_r = \sqrt{\frac{2t}{RC}} \begin{cases} t \approx shaping time (few 100 ns) \\ RC_{[ns/mm^2]} = \frac{180 R_{[M\Omega/\bullet]}}{d_{[\mu m]}/_{175}} & \text{Correct} \end{cases}$$

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Final ERAM layout choice for series production:

Considering pads of 11x10 mm<sup>2</sup> parameters

- 400 k $\Omega$ / $\Box$  DLC resistivity low resistivity
- 150  $\mu$ m thickness glue C<sub>dlc-pad/gnd</sub> ~ O(20pF)

#### $\rightarrow$ RC ~ O(100ns/mm<sup>2</sup>) Trade-off optimal charge spread VS spark protection

Gain not affected by resistivity (transparency to induced signals is guaranteed)

### **ERAM production ~ 50 detectors**



### **DLC layer: foil selection, QC**





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### **ERAM Series production experience: X-ray scan**

## X-rays Test Bench at CERN fundamental to

- 1) Qualify, characterize and calibrate all prototypes and series ERAMs
- 2) Support the development of detailed ERAM response model

A) Mesh Pulsing: before and after stiffener gluing
Aim: detector geom defects (eg pillar detach), stiffener gluing issues, electronic noise





B) X-ray scan of finalized detectors with final electronic modules. Remote controlled station for scanning with mm step fine steps
 Aim: QC and fine calibration in terms of gain, resolution and RC

RC map of ERAM30 RC map

### **ERAM Series production experience: X-ray scan**



 $1\mu m$  mesh-DLC gap variation => 10% variation in gain vorato

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### **ERAM Series production experience**



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De > Lower and upper bounds of bars: [Mean - 49%, Mean + 49%] of distribution (98% of values within bars)

### **ERAM Assembly and Operation experience**



#### **ERAM stability**

- We have operated 8 ERAM modules during ~ 7.7 days @ **CERN 2022** 
  - Intense beam activity
  - One ERAM module was not working during cosmic test (solved by hammering on it)
- We have observed no major issue
- The spark rate is between 0.8 and 1.7 per day (higher than 2uA)





Grev tent area in front of Clean Roor





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## The ND280 experiment: High Angle TPC highlights

### How does the signal look ? point deposition for example



Leading pad: highest and earliest signal

⇒ current induced on pads from by avalanche, ie ions signal (as electrons' signal is too fast)
 Adjacent pads: lower and later signals
 ⇒ current induced by potential field adjustments after electrons are collected by on DLC (current induction by "charge spread on resistive layer")

### **Reconstruction of charge deposition 1/2**





Recovering information about deposited Q is not trivial

Within our electronics shaping time scale in primary pads, the <u>signal of ions</u> is <u>«diluted»</u> by the <u>signal of charge spreading</u> => Need combining information of all pads (primary and secondary)

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### **Reconstruction of charge deposition 2/2**



Charge on DLC spreads along any direction including track direction **«longitudinal correlation»** across primary pads within our electronics shaping time scale



#### requires a dedicated signal formation model

### **ERAM response – Signal formation model**



### **ERAM detector response: reconstruction**

Use of the model for Reconstructing the charge deposition

Due to square shape of ERAM pads, the classical method (PRF+clustering) works OK only for tracks with horizontal or vertical direction (wrt pads coordinates)

Better methods use solutions of 1D or 2D telegraph equation in order to

- 1) compute the pattern templates for charge diffusion on DLC
- 2) calculate the overall expected signal waveform per each pad
- 3) find the best matching with the recorded waveforms

Its computationally heavy → different approximations are used for different analysis some examples and illustration algorithms and TPC performances

1) X-rays analysis – ERAM characterization

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- 2) Measurement of dE/dx Particle Identification
- 3) Track reconstruction momentum measurement

### **Reconstructing X-rays charge deposition**

 $Q_{pad}(t) = Solution of 2D Teq.$  for diffusion of initial Q deposited charge (point-like, delta-pulse initial conditions)

 $Q_{2} = 4 e^{-1}$ 

$$Q_{pad}(t) = \frac{Q_e}{4} \times \left[ erf(\frac{x_{\mathsf{high}} - x_0}{\sqrt{2}\sigma(t)}) - erf(\frac{x_{\mathsf{low}} - x_0}{\sqrt{2}\sigma(t)}) \right] \times \left[ erf(\frac{y_{\mathsf{high}} - y_0}{\sqrt{2}\sigma(t)}) - erf(\frac{y_{\mathsf{low}} - y_0}{\sqrt{2}\sigma(t)}) \right]$$

- Obtained from Telegrapher's equation for charge diffusion.
- Integrating charge density function over area of 1 readout pad.
- Parameterized by 5 variables:
  - Initial charge position • y<sub>0</sub>
  - t<sub>o</sub>: Time of charge deposition in leading pad

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- RC : Describes charge spreading
- Q : Total charge deposited in an event

 $x_{\mu}, x_{i}$ : Upper and lower bound of a pad in x-direction  $y_{H}, y_{L}$ : Upper and lower bound of a pad in y-direction



Q TLN ft


#### **Reconstructing X-rays charge deposition** WF templates



### **Extraction of RC and Gain maps from X-rays**



#### **Reconstructing Q along tracks**

For the reconstruction of the charge along the tracks two methods

- Waveform Sum (WS)
- Crossed Pad (XP)

Compare the performance of the two methods for dE/dx extraction



#### **Reconstructing Q along tracks: Waveform Sum**



### **Reconstructing Q along tracks: Crossed Pad (XP)**

- 1) Reconstruct tracks and consider only pads crossed (XP) by the track (primary pads)
- 2) Reconstruct original (ion induced) charge (Q) for each XP (given the track parameters there)
  - by  $Q = A \times (Q/A)$  where A is recorded amplitude on XP and rescaling ratio (Q/A) from Look Up tables (LUT)

LUTs build from model: original Q is distributed linearly over the segment for each XP so that solutions of 1D diffusion equations can be used



No clustering => potentially more accurate method because reconstructing full induced charge on primary pads
«dilution of ion signal» on a XP pad, due to charge spread over the pad is correctly taken into account
«longitudinal correlation» among adjacent XP pads, due to charge spread along track direction is accounted for
Fast method though based on model templates (long time is to generate LUTs ...)

### Reconstructing Q along tracks: Crossed Pad (XP)



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### dE/dx preliminary results: (WS) and (XP) methods



#### dE/dx preliminary results: (XP) method

Bethe-Bloch for different particles



### **PID preliminary results (XP) vs (WS)**

#### $e/\mu$ separation @ 1.5 GeV – Test Beam data (CERN PS T10)



#### Long tracks (~160cm)

#### **Reconstructing tracks**

For the reconstruction of the tracks

Log(Q) methods

**Full Waveform fit Method** 



### **Reconstructing tracks: trajectory fitting**



logQ method to reconstruct position in each cluster

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Helix fit performed on those reconstructed positions

Full Waveform fit Method – based on model & no clustering

1) Use all the pads associated to a track (Qmax values) to define a (v,u) local frame

- 2) Distribute "arbitrary" point charges along v axis separated by  $\Delta v$  (5mm) the Q per each point is a free parameter
- 3) Diffusion model to predict the waveform generated by point charges in surrounding pads

4) Move all points along the u axis to minimize the chi-square difference between measured waveforms and templates RungeKutta method to fit (u0, du/dv, q/p, t<sub>0</sub>, dv/dt)  $\chi^2 = \sum \sum \frac{0}{2}$ 





### **Spatial resolution: HATPC Top and Bottom**

260

220

160

RC [ns. 240F

#### Top HAT was equipped with ERAMs with larger RC variation w.r.t. Bottom



17.07.2023

High  $RC \rightarrow$  less charge spreading "flatter curve" Low  $RC \rightarrow$  more charge spreading

dX: distance from the center of the cluster and the real position

Non negligible RC variation among the same Endplate of the TPC

ERAM

Instead of using one parametrization of the log(Q), ERAM dependent

150

100

#### **Spatial resolution after reparameterization**



#### **Reconstructing tracks: momentum resolution**

 $\sigma_p$ /p momentum resolution as a function of track drift distance: simulated 700 MeV/c muons

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17.07.2023



#### **Event display, full ND280 detector!**

17.07.2023



#### Conclusions

Two new TPCs have been just installed in ND280 at JPARC

- Very stable operations in commissioning and technical runs
- Firs Neutrino Data taking just completed, restarting in October 2024

#### Field cages

- High ratio active/passive volume
- Highly effective insulation & E field uniformity
- Composite material technology exploited at the limit of the technology

#### Resistive MM with encapsulated anode

- Low resistivity & optimal charge spread & no sparks effects
- Series production allowed several detailed studies
- The ERAM technology is complex and delicate to produce as are all the resistive MPGDs. The expertise and excellent partnership with the CERN/PCB workshop enabled a high yield (~80%) of high-quality production
- New algorithms for square pads exploiting detailed response model under development

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### **Thanks to CERN**

We would like to express our gratitude for the continuous and extremely valuable support from CERN Burkard Schmidt, Roberto Guida, Frederic Merlet and colleagues  $\rightarrow$  Gas system EP-DT/ED-DT-FS Davide Tommasini, Roland Piccin, Sebastien Clement, Cedric Urscheler → Polymer lab/TE-MSC Rui de Olivera, Olivier Pizzirusso→ EP-DT-EF Eraldo Oliveri, Djunes Janssen  $\rightarrow$  EP-DT-DD Francesco Lanni, Lluis Secundino Miralles Verge Albert DE ROECK, Filippo Resnati → Neutrino Platform Ahmed Cherif, Jean Philipphe Rigaudt  $\rightarrow$  Metrology/TE-MSC-SMT Antje BEHRENS, Jean Christophe Gayde  $\rightarrow$  BE-GM-ESA Mauro Taborelli, Colette Charvet, Marcel Himmerlich  $\rightarrow$  TE-VSC-SCC Paolo Chiggiato  $\rightarrow$  TE-VSC

Patrick Muffat, Loredana ZENI Toberer, Laurence Planque, Stephanie Krattinger, Elsa Clerc→ SCE-SSC-LS





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Thanks to INFN support at CERN and the CEA ANTENNA colleagues





# **Just in Case**





CERN EP Detector Seminar | 19 July 2024 | S. Levorato

## Near Detector impact on Oscillation Analysis

- ND280 magnetized detector
- Select interactions in FGD and measure muon kinematics in the TPCs
- Separate samples based on number of reconstructed pions (CC0π, CC1π, CCNπ), protons, photons, etc
- Factor of ~3 reduction on the uncertainty on the event rates at the Far Detector



	Pre- ND FIT	Post- ND FIT
Sample	error	error
FHC $1R\mu$	11.1%	3.0%
RHC $1R\mu$	11.3%	4.0%
FHC 1Re	13.0%	4.7 %
RHC 1Re	12.1%	5.9%
FHC 1Re 1d.e.	18.7%	14.3%



(e) v-mode 1Re

(d) v-mode 1Rµ

# ND280 limitations



- Improve angular acceptance  $\nu$
- · Better reconstruction and usage of the hadronic part of the interactions!
  - Currently samples are selected according to their topology (0π, 1π, 1p, Nπ, ...) but the kinematics of the hadrons is not used in any way in the constraint on flux and x-sec systematics → plenty of additional information to be exploited
  - This is due to both, a low efficiency from ND280 to reconstruct hadrons and the difficulties in modeling the x-sec systematics for the hadronic part
    - With the upgrade we plan to improve the efficiency to reconstruct hadronic part



# ND280 Upgrade improvements





- High-Angle TPCs allow to reconstruct muons at any angle with respect to beam
- Super-FGD allow to fully reconstruct in 3D the tracks issued by v interactions →lower threshold and excellent resolution to reconstruct protons at any angle
  - Improved PID performances thanks to the high granularity and light yield
- Neutrons will also be reconstructed by using time of flight between vertex of v
  interaction and the neutron re-interaction in the detector



Protons → threshold down to 300 MeV/c



## Mantle resistance



Figura 4.2: Spostamento lungo R del punto di arrivo di un elettrone causato da una resistenza R<sub>man</sub> di un mantello isolante mille volte il valore della catena di resistori R. La distorsione é mostrata come funzione del punto di partenza z (Distanza dall'anodo).



## **ERAM Production - about 50 detectors**

Crucial steps in production (needed tuning)

- 1) Selecting DLC foil resistivity
- Large variations from DLC provider
- Value stable after annealing
- 2) Gluing steps by Pressing
- DLC to PCB

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- Stiffener to DLC-PCB

X-rays Test Bench at CERN was fundamental to

1) Qualify, characterize and calibrate all prototypes and series ERAMs

2) support the development of detailed ERAM response model



## Field Cage assembling, characterization at CERN

Gas contamination from Field Cage – other contaminants



Analysis of gas composition during cosmics test in May

More accurate estimates ongoing

N2 analysis
HCl acid

Evolution in time of components

- H2O (+ HO) contamination  $2\% \rightarrow c_{p}$  nsistent with other sensors (Vaisala)
- O2 peak below sensitivity → consistent with ppm level → need further checks

No HF acid a parently (below Ar++)

## **ERAM Series Production experience**

#### Effect of gas density on (gas)





GAIN

Effect of humidity on (gas)



## **ERAM detector response – Simulation**

Use of the model for Simulation of charge deposition in events Where additoinal ingredient is noise detailed modeled



## Reconstructing tracks dE/dx

dE/dx – comparison of SWF and XP methods on Test Beam data (4GeV electrons, DESY)



- Very good agreement overall
- Better resolution with XP with diagonal tracks



- Disagreement at small drift distance: reflects the track fitting quality
- Disagreement for Y scan: taken at small drift distance
- Disagreement for diagonal tracks: using only on correction function for WF<sub>sum</sub> is not suitable

## Reconstructing tracks – pattern recognition



- Time and charge definition for each hit
- Waveform multipeak search in order to differentiate vertices and crossing trajectories
- Merging between different ERAMs and End Plates



## Reconstructing tracks – trajectory fitting



(INFN T2K)

# T2K gas properties



T2K gas







INFŃ



Figure 31: A map of gain non-uniformit shift of the mean amplitude reconstruct pad under study with respect to the me





Figure 32: Schematic view of the DLC resulting in the non-uniformities observ The arrows represent the mechanical of when the soldermask is removed and rep



(c)

Figure 23: Comparing the features of an *RC* map (a) with the maps of two different basic-level variables (b) and (c) for ERAM-16. Variables var1 and var2 described in plot (d) are used to construct the maps (b) and (c) respectively.





Figure 23: Comparing the features of an RC map (a) with the maps of two different basic-level variables (b) and (c) for ERAM-16. Variables var1 and var2 described in plot (d) are used to construct the maps (b) and (c) respectively.

INFŃ


Figure 35: Effect of T/P on gain of an ERAM. The top and bottom x-axes represent the timelines of the two full detector scans.



Figure 36: Effect of relative humidity on gain of an ERAM. The top and bottom x-axes represent the timelines of the two full detector scans.

INF

Property Film Gauge	Typical	Value	Test Condition	Test Method
<b>Dielectric Strength</b> 25 μm (1 mil) 50 μm (2 mil) 75 μm (3 mil) 125 μm (5 mil)	<b>V/µm (kV/mm)</b> 303 240 201 154	<b>(V/mil)</b> (7700) (6100) (5,100) (3900)	60 Hz 1/4 in electrodes 500 V/sec rise	ASTM D-149
<b>Dielectric Constant</b> 25 μm (1 mil) 50 μm (2 mil) 75 μm (3 mil) 125 μm (5 mil)	3. 3. 3. 3. 3.	4 4 5 5	1 kHz	ASTM D-150
Dissipation Factor   25 μm (1 mil)   50 μm (2 mil)   75 μm (3 mil)   125 μm (5 mil)	0.00 0.00 0.00 0.00	018 020 020 026	1 kHz	ASTM D-150
Volume Resistivity 25 μm (1 mil) 50 μm (2 mil) 75 μm (3 mil) 125 μm (5 mil)	Ω• 1.5 × 1.5 × 1.4 × 1.0 ×	$\begin{array}{c} \text{cm} \\ 10^{17} \\ 10^{17} \\ 10^{17} \\ 10^{17} \end{array}$		ASTM D-257

### Table 7. Typical Electrical Properties of Kapton® Type HN and HPP-ST Films



Although a-C:H and ta-C belong to the same material family, they are not produced by the same coating process. a-C:H is achieved by PECVD (Plasma Enhanced Chemical Vapor deposition) in a gaseous environment. Whereas ta-C is produced by PVD-arc (Physical Vapor deposition arc) from a solid carbon target. PVD-arc technology enables the production of a ta-C coating with a higher percentage of sp3 hybridization without hydrogen and providing a higher hardness.

#### • Thermal annealing of ta-C is well known

- a-C:H as well. But,
- "Thermal annealing of a-C:H also reduces the stress, as in ta-C. However, as the bonding in a-C:H is less stable during annealing, annealing is less useful in this case."
- Mechanism described
  - Thermal annealing converts a small fraction of sp<sup>3</sup> (2%) to sp<sup>2</sup>
    - Distance between atoms is different between  $\mathsf{sp}^2$  and  $\mathsf{sp}^3$
    - New sp<sup>2</sup> structure has aligned electron orbitals
  - The conversion causes **exponential decrease** in resistivity
  - Compressive stress relieved by new sp<sup>2</sup> structure with electron orbitals aligned







 $\sigma$  orbital  $\longrightarrow \pi$  orbital



#### Kensuke Yamamoto<sup>A</sup>

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A breakdown of the resistive layer means creating a low Ohmic channel in the layer

# T2K+SK joint analysis

- T2K has good sensitivity to  $\delta_{\text{CP}}$  but mild sensitivity to mass ordering
- SK has good constraint on mass ordering but not on  $\delta_{\text{CP}}$
- Adding SK atmospheric sample allows to break the degeneracies between the CP violation parameter δ<sub>CP</sub> and the mass ordering → boost sensitivity to CP



## Mass ordering and $\theta_{23}$ octant

- Slight preference for normal ordering and upper octant but none of them is significative
  - Bayes factor NO/IO = 3.3
  - Bayes factor  $(\theta_{23}>0.5)/(\theta_{23}<0.5) = 2.6$

	$\sin^2\theta_{23} < 0.5$	$\sin^2\theta_{23} > 0.5$	Sum
NH $(\Delta m^2_{32}>0)$	0.23	0.54	0.77
IH $(\Delta m^2_{32} < 0)$	0.05	0.18	0.23
Sum	0.28	0.72	1.00



TZK



Both experiments individually prefer normal ordering and  $\delta CP$ ~- $\pi/2$ , T2K prefers upper octant, SK prefer lower octant

We performed Bayesian and Frequentist analyses  $\rightarrow$  frequentist analyses shown today

The CP-conserving value of the Jarlskog invariant is excluded with a significance between 1.9 and 2  $\sigma$ 



- NOvA & T2K's first joint results:
  - <sup>-</sup> Yield strong constraint on  $\Delta m_{32}^2$
  - Weakly prefer IO or NO depending on which reactor constraint is applied
  - Strongly favor CP violation in Inverted Ordering
- Collaborations in active discussion about joint fit next steps

### NOvA-T2K joint fit: takeaways







And this matches the resistivity direct measurement (C is very well constrained by the thickness of insulator)



R inhomogenities in the sputtering are clearly visible in the direction perpendicular to the drum rotation axis.